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#### Details

Decalis	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	10MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	22
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	368 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	A/D 5x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f876-10e-sp

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

TABLE 1-1:	PIC16F873 AND PIC16F876 PINOUT DESCRIPTION
IADLE I-I.	FIG 10F0/3 AND FIG 10F0/0 FINOUT DESCRIFTION

Pin Name	DIP Pin#	SOIC Pin#	I/O/P Type	Buffer Type	Description
OSC1/CLKIN	9	9	I	ST/CMOS <sup>(3)</sup>	Oscillator crystal input/external clock source input.
OSC2/CLKOUT	10	10	0	—	Oscillator crystal output. Connects to crystal or resonator in crystal oscillator mode. In RC mode, the OSC2 pin outputs CLKOUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate.
MCLR/Vpp	1	1	I/P	ST	Master Clear (Reset) input or programming voltage input. This pin is an active low RESET to the device.
					PORTA is a bi-directional I/O port.
RA0/AN0	2	2	I/O	TTL	RA0 can also be analog input0.
RA1/AN1	3	3	I/O	TTL	RA1 can also be analog input1.
RA2/AN2/VREF-	4	4	I/O	TTL	RA2 can also be analog input2 or negative analog reference voltage.
RA3/AN3/VREF+	5	5	I/O	TTL	RA3 can also be analog input3 or positive analog reference voltage.
RA4/T0CKI	6	6	I/O	ST	RA4 can also be the clock input to the Timer0 module. Output is open drain type.
RA5/SS/AN4	7	7	I/O	TTL	RA5 can also be analog input4 or the slave select for the synchronous serial port.
					PORTB is a bi-directional I/O port. PORTB can be software programmed for internal weak pull-up on all inputs.
RB0/INT	21	21	I/O	TTL/ST <sup>(1)</sup>	RB0 can also be the external interrupt pin.
RB1	22	22	I/O	TTL	
RB2	23	23	I/O	TTL	
RB3/PGM	24	24	I/O	TTL	RB3 can also be the low voltage programming input.
RB4	25	25	I/O	TTL	Interrupt-on-change pin.
RB5	26	26	I/O	TTL	Interrupt-on-change pin.
RB6/PGC	27	27	I/O	TTL/ST <sup>(2)</sup>	Interrupt-on-change pin or In-Circuit Debugger pin. Serial programming clock.
RB7/PGD	28	28	I/O	TTL/ST <sup>(2)</sup>	Interrupt-on-change pin or In-Circuit Debugger pin. Serial programming data.
					PORTC is a bi-directional I/O port.
RC0/T1OSO/T1CKI	11	11	I/O	ST	RC0 can also be the Timer1 oscillator output or Timer1 clock input.
RC1/T1OSI/CCP2	12	12	I/O	ST	RC1 can also be the Timer1 oscillator input or Capture2 input/Compare2 output/PWM2 output.
RC2/CCP1	13	13	I/O	ST	RC2 can also be the Capture1 input/Compare1 output/ PWM1 output.
RC3/SCK/SCL	14	14	I/O	ST	RC3 can also be the synchronous serial clock input/outpu for both SPI and I <sup>2</sup> C modes.
RC4/SDI/SDA	15	15	I/O	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O (I <sup>2</sup> C mode).
RC5/SDO	16	16	I/O	ST	RC5 can also be the SPI Data Out (SPI mode).
RC6/TX/CK	17	17	I/O	ST	RC6 can also be the USART Asynchronous Transmit or Synchronous Clock.
RC7/RX/DT	18	18	I/O	ST	RC7 can also be the USART Asynchronous Receive or Synchronous Data.
Vss	8, 19	8, 19	Р	_	Ground reference for logic and I/O pins.
Vdd	20	20	Р	_	Positive supply for logic and I/O pins.
Legend: I = input	0 = outp — = Not			input/output = TTL input	P = power ST = Schmitt Trigger input

Note 1: This buffer is a Schmitt Trigger input when configured as the external interrupt.

This buffer is a Schmitt Trigger input when used in Serial Programming mode.
 This buffer is a Schmitt Trigger input when configured in RC oscillator mode and a CMOS input otherwise.

#### 2.2.2.7 PIR2 Register

The PIR2 register contains the flag bits for the CCP2 interrupt, the SSP bus collision interrupt and the EEPROM write operation interrupt.

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

### REGISTER 2-7: PIR2 REGISTER (ADDRESS 0Dh)

R = Readable bit

- n = Value at POR

U-0	R/W-0	U-0	R/W-0	R/W-0	U-0	U-0	R/W-0
-	Reserved	—	EEIF	BCLIF	—	—	CCP2IF
bit 7							bit 0

Unimplemented: Read as '0'
Reserved: Always maintain this bit clear
Unimplemented: Read as '0'
EEIF: EEPROM Write Operation Interrupt Flag bit
<ul><li>1 = The write operation completed (must be cleared in software)</li><li>0 = The write operation is not complete or has not been started</li></ul>
BCLIF: Bus Collision Interrupt Flag bit
<ul> <li>1 = A bus collision has occurred in the SSP, when configured for I2C Master mode</li> <li>0 = No bus collision has occurred</li> </ul>
Unimplemented: Read as '0'
CCP2IF: CCP2 Interrupt Flag bit
Capture mode:
<ul> <li>1 = A TMR1 register capture occurred (must be cleared in software)</li> <li>0 = No TMR1 register capture occurred</li> <li><u>Compare mode:</u></li> </ul>
<ul> <li>1 = A TMR1 register compare match occurred (must be cleared in software)</li> <li>0 = No TMR1 register compare match occurred</li> <li><u>PWM mode:</u></li> </ul>
Unused Leaend:

W = Writable bit

'1' = Bit is set

U = Unimplemented bit, read as '0'

x = Bit is unknown

'0' = Bit is cleared

NOTES:

## 4.0 DATA EEPROM AND FLASH PROGRAM MEMORY

The Data EEPROM and FLASH Program Memory are readable and writable during normal operation over the entire VDD range. These operations take place on a single byte for Data EEPROM memory and a single word for Program memory. A write operation causes an erase-then-write operation to take place on the specified byte or word. A bulk erase operation may not be issued from user code (which includes removing code protection).

Access to program memory allows for checksum calculation. The values written to program memory do not need to be valid instructions. Therefore, up to 14-bit numbers can be stored in memory for use as calibration parameters, serial numbers, packed 7-bit ASCII, etc. Executing a program memory location containing data that form an invalid instruction, results in the execution of a NOP instruction.

The EEPROM Data memory is rated for high erase/ write cycles (specification D120). The FLASH program memory is rated much lower (specification D130), because EEPROM data memory can be used to store frequently updated values. An on-chip timer controls the write time and it will vary with voltage and temperature, as well as from chip to chip. Please refer to the specifications for exact limits (specifications D122 and D133).

A byte or word write automatically erases the location and writes the new value (erase before write). Writing to EEPROM data memory does not impact the operation of the device. Writing to program memory will cease the execution of instructions until the write is complete. The program memory cannot be accessed during the write. During the write operation, the oscillator continues to run, the peripherals continue to function and interrupt events will be detected and essentially "queued" until the write is complete. When the write completes, the next instruction in the pipeline is executed and the branch to the interrupt vector will take place, if the interrupt is enabled and occurred during the write.

Read and write access to both memories take place indirectly through a set of Special Function Registers (SFR). The six SFRs used are:

- EEDATA
- EEDATH
- EEADR
- EEADRH
- EECON1
- EECON2

The EEPROM data memory allows byte read and write operations without interfering with the normal operation of the microcontroller. When interfacing to EEPROM data memory, the EEADR register holds the address to be accessed. Depending on the operation, the EEDATA register holds the data to be written, or the data read, at the address in EEADR. The PIC16F873/874 devices have 128 bytes of EEPROM data memory and therefore, require that the MSb of EEADR remain clear. The EEPROM data memory on these devices do not wrap around to 0, i.e., 0x80 in the EEADR does not map to 0x00. The PIC16F876/877 devices have 256 bytes of EEPROM data memory and therefore, uses all 8-bits of the EEADR.

The FLASH program memory allows non-intrusive read access, but write operations cause the device to stop executing instructions, until the write completes. When interfacing to the program memory, the EEADRH:EEADR registers form a two-byte word, which holds the 13-bit address of the memory location being accessed. The register combination of EEDATH:EEDATA holds the 14-bit data for writes, or reflects the value of program memory after a read operation. Just as in EEPROM data memory accesses, the value of the EEADRH:EEADR registers must be within the valid range of program memory, depending on the device: 0000h to 1FFFh for the PIC16F873/874. or 0000h to 3FFFh for the PIC16F876/877. Addresses outside of this range do not wrap around to 0000h (i.e., 4000h does not map to 0000h on the PIC16F877).

## 4.1 EECON1 and EECON2 Registers

The EECON1 register is the control register for configuring and initiating the access. The EECON2 register is not a physically implemented register, but is used exclusively in the memory write sequence to prevent inadvertent writes.

There are many bits used to control the read and write operations to EEPROM data and FLASH program memory. The EEPGD bit determines if the access will be a program or data memory access. When clear, any subsequent operations will work on the EEPROM data memory. When set, all subsequent operations will operate in the program memory.

Read operations only use one additional bit, RD, which initiates the read operation from the desired memory location. Once this bit is set, the value of the desired memory location will be available in the data registers. This bit cannot be cleared by firmware. It is automatically cleared at the end of the read operation. For EEPROM data memory reads, the data will be available in the EEDATA register in the very next instruction cycle after the RD bit is set. For program memory reads, the data will be loaded into the EEDATH:EEDATA registers, following the second instruction after the RD bit is set.

## 5.0 TIMER0 MODULE

The Timer0 module timer/counter has the following features:

- 8-bit timer/counter
- Readable and writable
- 8-bit software programmable prescaler
- · Internal or external clock select
- Interrupt on overflow from FFh to 00h
- Edge select for external clock

Figure 5-1 is a block diagram of the Timer0 module and the prescaler shared with the WDT.

Additional information on the Timer0 module is available in the PIC<sup>®</sup> MCU Mid-Range Family Reference Manual (DS33023).

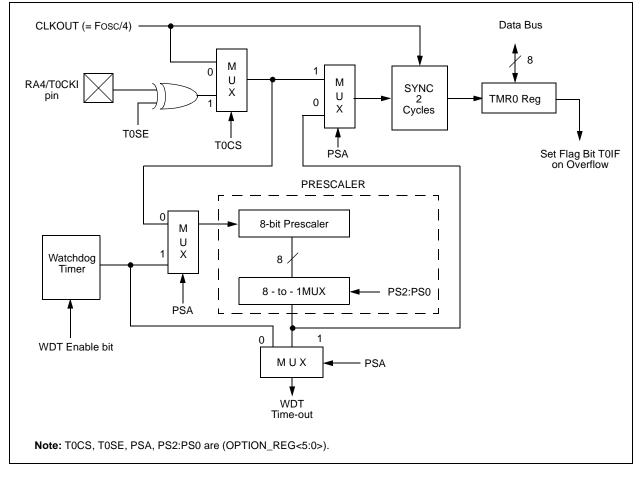
Timer mode is selected by clearing bit TOCS (OPTION\_REG<5>). In Timer mode, the Timer0 module will increment every instruction cycle (without prescaler). If the TMR0 register is written, the increment is inhibited for the following two instruction cycles. The user can work around this by writing an adjusted value to the TMR0 register. Counter mode is selected by setting bit T0CS (OPTION\_REG<5>). In Counter mode, Timer0 will increment either on every rising, or falling edge of pin RA4/T0CKI. The incrementing edge is determined by the Timer0 Source Edge Select bit, T0SE (OPTION\_REG<4>). Clearing bit T0SE selects the rising edge. Restrictions on the external clock input are discussed in detail in Section 5.2.

The prescaler is mutually exclusively shared between the Timer0 module and the Watchdog Timer. The prescaler is not readable or writable. Section 5.3 details the operation of the prescaler.

## 5.1 Timer0 Interrupt

The TMR0 interrupt is generated when the TMR0 register overflows from FFh to 00h. This overflow sets bit T0IF (INTCON<2>). The interrupt can be masked by clearing bit T0IE (INTCON<5>). Bit T0IF must be cleared in software by the Timer0 module Interrupt Service Routine before re-enabling this interrupt. The TMR0 interrupt cannot awaken the processor from SLEEP, since the timer is shut-off during SLEEP.

FIGURE 5-1: BLOCK DIAGRAM OF THE TIMER0/WDT PRESCALER



### 6.7 Resetting of Timer1 Register Pair (TMR1H, TMR1L)

TMR1H and TMR1L registers are not reset to 00h on a POR, or any other RESET, except by the CCP1 and CCP2 special event triggers.

T1CON register is reset to 00h on a Power-on Reset, or a Brown-out Reset, which shuts off the timer and leaves a 1:1 prescale. In all other RESETS, the register is unaffected.

### 6.8 Timer1 Prescaler

The prescaler counter is cleared on writes to the TMR1H or TMR1L registers.

## TABLE 6-2: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
0Bh,8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF <sup>(1)</sup>	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
8Ch	PIE1	PSPIE <sup>(1)</sup>	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
0Eh	TMR1L	Holding R	egister for th	ne Least Sig	nificant Byte	of the 16-bit	TMR1 Regi	ster		xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding R	Holding Register for the Most Significant Byte of the 16-bit TMR1 Register							xxxx xxxx	uuuu uuuu
10h	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00 0000	uu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the Timer1 module.

Note 1: Bits PSPIE and PSPIF are reserved on the PIC16F873/876; always maintain these bits clear.

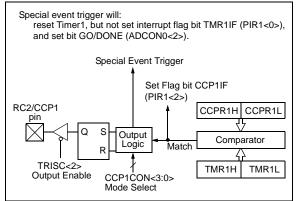
## 8.2 Compare Mode

In Compare mode, the 16-bit CCPR1 register value is constantly compared against the TMR1 register pair value. When a match occurs, the RC2/CCP1 pin is:

- Driven high
- Driven low
- Remains unchanged

The action on the pin is based on the value of control bits CCP1M3:CCP1M0 (CCP1CON<3:0>). At the same time, interrupt flag bit CCP1IF is set.

#### FIGURE 8-2: COMPARE MODE OPERATION BLOCK DIAGRAM



#### 8.2.1 CCP PIN CONFIGURATION

The user must configure the RC2/CCP1 pin as an output by clearing the TRISC<2> bit.

Note: Clearing the CCP1CON register will force the RC2/CCP1 compare output latch to the default low level. This is not the PORTC I/O data latch.

### 8.2.2 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode, or Synchronized Counter mode, if the CCP module is using the compare feature. In Asynchronous Counter mode, the compare operation may not work.

#### 8.2.3 SOFTWARE INTERRUPT MODE

When Generate Software Interrupt mode is chosen, the CCP1 pin is not affected. The CCPIF bit is set, causing a CCP interrupt (if enabled).

#### 8.2.4 SPECIAL EVENT TRIGGER

In this mode, an internal hardware trigger is generated, which may be used to initiate an action.

The special event trigger output of CCP1 resets the TMR1 register pair. This allows the CCPR1 register to effectively be a 16-bit programmable period register for Timer1.

The special event trigger output of CCP2 resets the TMR1 register pair and starts an A/D conversion (if the A/D module is enabled).

**Note:** The special event trigger from the CCP1and CCP2 modules will not set interrupt flag bit TMR1IF (PIR1<0>).

#### 8.3.3 SETUP FOR PWM OPERATION

The following steps should be taken when configuring the CCP module for PWM operation:

- 1. Set the PWM period by writing to the PR2 register.
- 2. Set the PWM duty cycle by writing to the CCPR1L register and CCP1CON<5:4> bits.
- 3. Make the CCP1 pin an output by clearing the TRISC<2> bit.
- 4. Set the TMR2 prescale value and enable Timer2 by writing to T2CON.
- 5. Configure the CCP1 module for PWM operation.

## TABLE 8-3: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 20 MHz

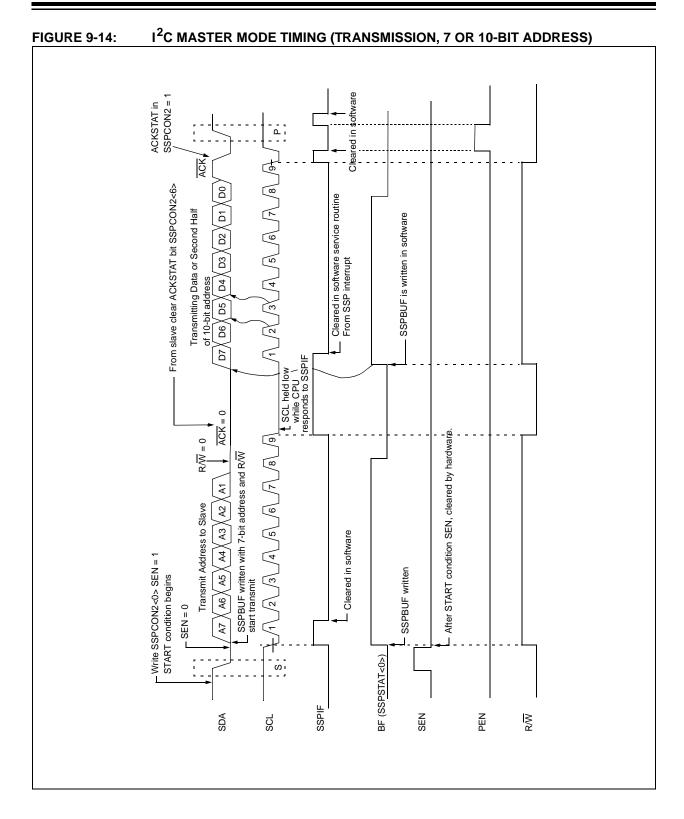
PWM Frequency	1.22 kHz	4.88 kHz	19.53 kHz	78.12kHz	156.3 kHz	208.3 kHz
Timer Prescaler (1, 4, 16)	16	4	1	1	1	1
PR2 Value	0xFFh	0xFFh	0xFFh	0x3Fh	0x1Fh	0x17h
Maximum Resolution (bits)	10	10	10	8	7	5.5

#### TABLE 8-4: REGISTERS ASSOCIATED WITH CAPTURE, COMPARE, AND TIMER1

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
0Bh,8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF <sup>(1)</sup>	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
0Dh	PIR2	—	_	_	_	—	—	_	CCP2IF	0	0
8Ch	PIE1	PSPIE <sup>(1)</sup>	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
8Dh	PIE2	—	_	—	_	_	—	—	CCP2IE	0	0
87h	TRISC	PORTC D	PORTC Data Direction Register								1111 1111
0Eh	TMR1L	Holding R	egister for	r the Least	Significant E	Byte of the 1	6-bit TMR1	Register		xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding R	egister for	r the Most S	Significant B	yte of the 16	6-bit TMR1	Register		xxxx xxxx	uuuu uuuu
10h	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00 0000	uu uuuu
15h	CCPR1L	Capture/C	ompare/F	WM Regist	ter1 (LSB)					XXXX XXXX	uuuu uuuu
16h	CCPR1H	Capture/C	ompare/F	WM Regist	ter1 (MSB)					xxxx xxxx	uuuu uuuu
17h	CCP1CON	—	—	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
1Bh	CCPR2L	Capture/C	Capture/Compare/PWM Register2 (LSB)							xxxx xxxx	uuuu uuuu
1Ch	CCPR2H	Capture/C	Capture/Compare/PWM Register2 (MSB)								uuuu uuuu
1Dh	CCP2CON	—	—	CCP2X	CCP2Y	CCP2M3	CCP2M2	CCP2M1	CCP2M0	00 0000	00 0000

 $\label{eq:legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by Capture and Timer1.$ 

Note 1: The PSP is not implemented on the PIC16F873/876; always maintain these bits clear.



#### 9.2.18.1 Bus Collision During a START Condition

During a START condition, a bus collision occurs if:

- a) SDA or SCL are sampled low at the beginning of the START condition (Figure 9-20).
- b) SCL is sampled low before SDA is asserted low (Figure 9-21).

During a START condition, both the SDA and the SCL pins are monitored. If either the SDA pin <u>or</u> the SCL pin is already low, then these events all occur:

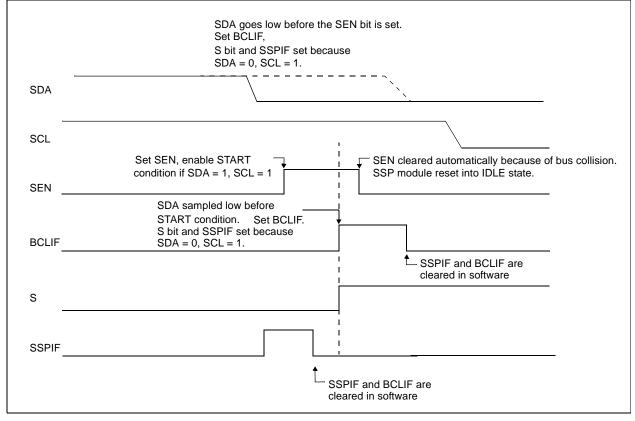
- the START condition is aborted,
- and the BCLIF flag is set,
- <u>and</u> the SSP module is reset to its IDLE state (Figure 9-20).

The START condition begins with the SDA and SCL pins de-asserted. When the SDA pin is sampled high, the baud rate generator is loaded from SSPADD<6:0> and counts down to 0. If the SCL pin is sampled low while SDA is high, a bus collision occurs, because it is assumed that another master is attempting to drive a data '1' during the START condition.

If the SDA pin is sampled low during this count, the BRG is reset and the SDA line is asserted early (Figure 9-22). If, however, a '1' is sampled on the SDA pin, the SDA pin is asserted low at the end of the BRG count. The baud rate generator is then reloaded and counts down to 0. During this time, if the SCL pins are sampled as '0', a bus collision does not occur. At the end of the BRG count, the SCL pin is asserted low.

Note: The reason that bus collision is not a factor during a START condition is that no two bus masters can assert a START condition at the exact same time. Therefore, one master will always assert SDA before the other. This condition does not cause a bus collision, because the two masters must be allowed to arbitrate the first address following the START condition. If the address is the same, arbitration must be allowed to continue into the data portion, Repeated START, or STOP conditions.





## TABLE 10-3: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 0)

BAUD	Fosc = 20 MHz			F	osc = 16 N	IHz	F	Fosc = 10 MHz		
RATE (K)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	
0.3	-	-	-	-	-	-	-	-	-	
1.2	1.221	1.75	255	1.202	0.17	207	1.202	0.17	129	
2.4	2.404	0.17	129	2.404	0.17	103	2.404	0.17	64	
9.6	9.766	1.73	31	9.615	0.16	25	9.766	1.73	15	
19.2	19.531	1.72	15	19.231	0.16	12	19.531	1.72	7	
28.8	31.250	8.51	9	27.778	3.55	8	31.250	8.51	4	
33.6	34.722	3.34	8	35.714	6.29	6	31.250	6.99	4	
57.6	62.500	8.51	4	62.500	8.51	3	52.083	9.58	2	
HIGH	1.221	-	255	0.977	-	255	0.610	-	255	
LOW	312.500	-	0	250.000	-	0	156.250	-	0	

DAUD		Fosc = 4 M	Hz	Fo	sc = 3.6864	MHz
BAUD RATE (K)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	0.300	0	207	0.3	0	191
1.2	1.202	0.17	51	1.2	0	47
2.4	2.404	0.17	25	2.4	0	23
9.6	8.929	6.99	6	9.6	0	5
19.2	20.833	8.51	2	19.2	0	2
28.8	31.250	8.51	1	28.8	0	1
33.6	-	-	-	-	-	-
57.6	62.500	8.51	0	57.6	0	0
HIGH	0.244	-	255	0.225	-	255
LOW	62.500	-	0	57.6	-	0

## TABLE 10-4: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 1)

BAUD	Fosc = 20 MHz			F	osc = 16 M	Hz	Fosc = 10 MHz		
RATE (K)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	-	-	-	-	-	-	-	-	-
1.2	-	-	-	-	-	-	-	-	-
2.4	-	-	-	-	-	-	2.441	1.71	255
9.6	9.615	0.16	129	9.615	0.16	103	9.615	0.16	64
19.2	19.231	0.16	64	19.231	0.16	51	19.531	1.72	31
28.8	29.070	0.94	42	29.412	2.13	33	28.409	1.36	21
33.6	33.784	0.55	36	33.333	0.79	29	32.895	2.10	18
57.6	59.524	3.34	20	58.824	2.13	16	56.818	1.36	10
HIGH	4.883	-	255	3.906	-	255	2.441	-	255
LOW	1250.000	-	0	1000.000		0	625.000	-	0

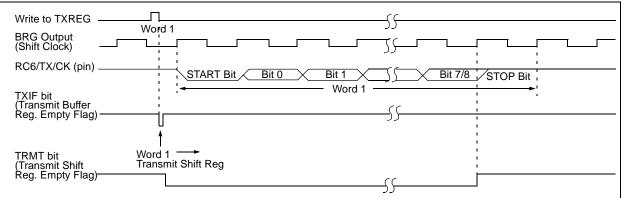
BAUD	F	osc = 4 MH	łz	Fosc = 3.6864 MHz			
RATE (K)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	
0.3	-	-	-	-	-	-	
1.2	1.202	0.17	207	1.2	0	191	
2.4	2.404	0.17	103	2.4	0	95	
9.6	9.615	0.16	25	9.6	0	23	
19.2	19.231	0.16	12	19.2	0	11	
28.8	27.798	3.55	8	28.8	0	7	
33.6	35.714	6.29	6	32.9	2.04	6	
57.6	62.500	8.51	3	57.6	0	3	
HIGH	0.977	-	255	0.9	-	255	
LOW	250.000	-	0	230.4	-	0	

When setting up an Asynchronous Transmission, follow these steps:

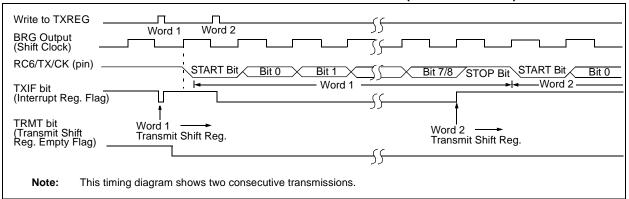
- 1. Initialize the SPBRG register for the appropriate baud rate. If a high speed baud rate is desired, set bit BRGH (Section 10.1).
- 2. Enable the asynchronous serial port by clearing bit SYNC and setting bit SPEN.
- 3. If interrupts are desired, then set enable bit TXIE.
- 4. If 9-bit transmission is desired, then set transmit bit TX9.

- 5. Enable the transmission by setting bit TXEN, which will also set bit TXIF.
- 6. If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- 7. Load data to the TXREG register (starts transmission).
- 8. If using interrupts, ensure that GIE and PEIE (bits 7 and 6) of the INTCON register are set.

#### FIGURE 10-2: ASYNCHRONOUS MASTER TRANSMISSION



#### FIGURE 10-3: ASYNCHRONOUS MASTER TRANSMISSION (BACK TO BACK)



#### TABLE 10-5: REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
0Bh, 8Bh, 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	T0IF	INTF	R0IF	0000 000x	0000 000u
0Ch	PIR1	PSPIF <sup>(1)</sup>	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
19h	TXREG	USART Tra	insmit Re	gister						0000 0000	0000 0000
8Ch	PIE1	PSPIE <sup>(1)</sup>	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Generato	or Register	·					0000 0000	0000 0000

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for asynchronous transmission. **Note 1:** Bits PSPIE and PSPIF are reserved on the PIC16F873/876; always maintain these bits clear.

## 12.3 **RESET**

The PIC16F87X differentiates between various kinds of RESET:

- Power-on Reset (POR)
- MCLR Reset during normal operation
- MCLR Reset during SLEEP
- WDT Reset (during normal operation)
- WDT Wake-up (during SLEEP)
- Brown-out Reset (BOR)

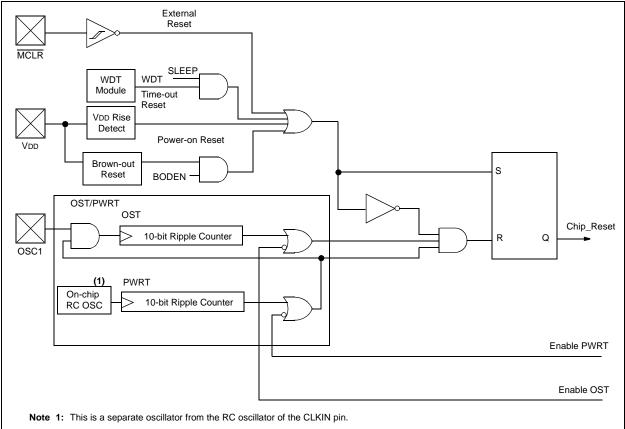
Some registers are not affected in any RESET condition. Their status is unknown on POR and unchanged in any other RESET. Most other registers are reset to a "RESET state" on Power-on Reset (POR), on the MCLR and WDT Reset, on MCLR Reset during SLEEP, and Brown-out Reset (BOR). They are not affected by a WDT Wake-up, which is viewed as the resumption of normal operation. The  $\overline{\text{TO}}$  and  $\overline{\text{PD}}$  bits are set or cleared differently in different RESET situations as indicated in Table 12-4. These bits are used in software to determine the nature of the RESET. See Table 12-6 for a full description of RESET states of all registers.

A simplified block diagram of the On-Chip Reset Circuit is shown in Figure 12-4.

These devices have a MCLR noise filter in the MCLR Reset path. The filter will detect and ignore small pulses.

It should be noted that a WDT Reset does not drive  $\overline{\text{MCLR}}$  pin low.





MOVF	Move f
Syntax:	[ label ] MOVF f,d
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in [0,1] \end{array}$
Operation:	(f) $\rightarrow$ (destination)
Status Affected:	Z
Description:	The contents of register f are moved to a destination dependant upon the status of d. If $d = 0$ , destination is W register. If $d = 1$ , the destination is file register f itself. d = 1 is useful to test a file register, since status flag Z is affected.

NOP	No Operation
Syntax:	[ label ] NOP
Operands:	None
Operation:	No operation
Status Affected:	None
Description:	No operation.

MOVLW	Move Literal to W
Syntax:	[ <i>label</i> ] MOVLW k
Operands:	$0 \leq k \leq 255$
Operation:	$k \rightarrow (W)$
Status Affected:	None
Description:	The eight bit literal 'k' is loaded into W register. The don't cares will assemble as 0's.

RETFIE	Return from Interrupt
Syntax:	[label] RETFIE
Operands:	None
Operation:	$TOS \rightarrow PC, \\ 1 \rightarrow GIE$
Status Affected:	None

MOVWF	Move W to f
Syntax:	[ <i>label</i> ] MOVWF f
Operands:	$0 \leq f \leq 127$
Operation:	$(W) \rightarrow (f)$
Status Affected:	None
Description:	Move data from W register to register 'f'.

RETLW	Return with Literal in W
Syntax:	[ <i>label</i> ] RETLW k
Operands:	$0 \leq k \leq 255$
Operation:	$k \rightarrow (W);$ TOS $\rightarrow$ PC
Status Affected:	None
Description:	The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.

### 14.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK object linker combines relocatable objects created by the MPASM assembler and the MPLAB C17 and MPLAB C18 C compilers. It can also link relocatable objects from pre-compiled libraries, using directives from a linker script.

The MPLIB object librarian is a librarian for precompiled code to be used with the MPLINK object linker. When a routine from a library is called from another source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications. The MPLIB object librarian manages the creation and modification of library files.

The MPLINK object linker features include:

- Integration with MPASM assembler and MPLAB C17 and MPLAB C18 C compilers.
- Allows all memory areas to be defined as sections to provide link-time flexibility.

The MPLIB object librarian features include:

- Easier linking because single libraries can be included instead of many smaller files.
- Helps keep code maintainable by grouping related modules together.
- Allows libraries to be created and modules to be added, listed, replaced, deleted or extracted.

## 14.5 MPLAB SIM Software Simulator

The MPLAB SIM software simulator allows code development in a PC-hosted environment by simulating the PIC MCU series microcontrollers on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a file, or user-defined key press, to any of the pins. The execution can be performed in single step, execute until break, or trace mode.

The MPLAB SIM simulator fully supports symbolic debugging using the MPLAB C17 and the MPLAB C18 C compilers and the MPASM assembler. The software simulator offers the flexibility to develop and debug code outside of the laboratory environment, making it an excellent multiproject software development tool.

## 14.6 MPLAB ICE High Performance Universal In-Circuit Emulator with MPLAB IDE

The MPLAB ICE universal in-circuit emulator is intended to provide the product development engineer with a complete microcontroller design tool set for PIC MCU microcontrollers (MCUs). Software control of the MPLAB ICE in-circuit emulator is provided by the MPLAB Integrated Development Environment (IDE), which allows editing, building, downloading and source debugging from a single environment.

The MPLAB ICE 2000 is a full-featured emulator system with enhanced trace, trigger and data monitoring features. Interchangeable processor modules allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the MPLAB ICE in-circuit emulator allows expansion to support new PIC microcontrollers.

The MPLAB ICE in-circuit emulator system has been designed as a real-time emulation system, with advanced features that are generally found on more expensive development tools. The PC platform and Microsoft<sup>®</sup> Windows environment were chosen to best make these features available to you, the end user.

## 14.7 ICEPIC In-Circuit Emulator

The ICEPIC low cost, in-circuit emulator is a solution for the Microchip Technology PIC16C5X, PIC16C6X, PIC16C7X and PIC16CXXX families of 8-bit One-Time-Programmable (OTP) microcontrollers. The modular system can support different subsets of PIC16C5X or PIC16CXXX products through the use of interchangeable personality modules, or daughter boards. The emulator is capable of emulating without target application circuitry being present.

#### 15.2 DC Characteristics: PIC16F873/874/876/877-04 (Commercial, Industrial) PIC16F873/874/876/877-20 (Commercial, Industrial) PIC16LF873/874/876/877-04 (Commercial, Industrial)

DC CHA	RACTE	RISTICS	Operating	i temp	erature	-40°C 0°C	The second seco
Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
	VIL	Input Low Voltage					
		I/O ports					
D030		with TTL buffer	Vss	—	0.15Vdd	V	For entire VDD range
D030A			Vss	—	0.8V	V	$4.5V \le VDD \le 5.5V$
D031		with Schmitt Trigger buffer	Vss	—	0.2Vdd	V	
D032		MCLR, OSC1 (in RC mode)	Vss	—	0.2Vdd	V	
D033		OSC1 (in XT, HS and LP)	Vss	—	0.3Vdd	V	(Note 1)
		Ports RC3 and RC4		—			
D034		with Schmitt Trigger buffer	Vss	—	0.3Vdd	V	For entire VDD range
D034A		with SMBus	-0.5	—	0.6	V	for VDD = $4.5$ to $5.5$ V
	Vih	Input High Voltage			r		1
		I/O ports		—			
D040		with TTL buffer	2.0	—	Vdd	-	$4.5V \leq VDD \leq 5.5V$
D040A			0.25VDD + 0.8V	_	Vdd	V	For entire VDD range
D041		with Schmitt Trigger buffer	0.8Vdd	—	Vdd	V	For entire VDD range
D042		MCLR	0.8Vdd	—	Vdd	V	
D042A		OSC1 (XT, HS and LP)	0.7Vdd	—	Vdd	V	(Note 1)
D043		OSC1 (in RC mode) Ports RC3 and RC4	0.9Vdd	—	Vdd	V	
D044		with Schmitt Trigger buffer	0.7Vdd	—	Vdd	V	For entire VDD range
D044A		with SMBus	1.4	—	5.5	V	for VDD = $4.5$ to $5.5$ V
D070	IPURB	PORTB Weak Pull-up Current	50	250	400	μA	VDD = 5V, VPIN = VSS, -40°C TO +85°C
	lı∟	Input Leakage Current <sup>(2, 3)</sup>					
D060		I/O ports	—	—	±1	μΑ	$Vss \le VPIN \le VDD,$ Pin at hi-impedance
D061		MCLR, RA4/T0CKI	_	_	±5	uΑ	$Vss \leq VPIN \leq VDD$
D063		OSC1	—	_	±5	•	$Vss \le VPIN \le VDD$ , XT, HS and LP osc configuration

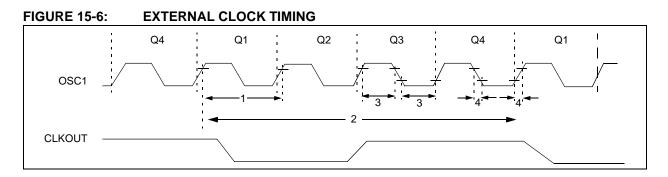
These parameters are characterized but not tested.

Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance † only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16F87X be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

**3:** Negative current is defined as current sourced by the pin.



#### TABLE 15-1: EXTERNAL CLOCK TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
	Fosc	External CLKIN Frequency	DC		4	MHz	XT and RC osc mode
		(Note 1)	DC	_	4	MHz	HS osc mode (-04)
			DC	_	10	MHz	HS osc mode (-10)
			DC	_	20	MHz	HS osc mode (-20)
			DC	—	200	kHz	LP osc mode
		Oscillator Frequency	DC		4	MHz	RC osc mode
		(Note 1)	0.1	—	4	MHz	XT osc mode
			4	—	10	MHz	HS osc mode (-10)
			4	_	20	MHz	HS osc mode (-20)
			5		200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250		_	ns	XT and RC osc mode
		(Note 1)	250	_	—	ns	HS osc mode (-04)
			100	_	—	ns	HS osc mode (-10)
			50	—	—	ns	HS osc mode (-20)
			5	—	—	μS	LP osc mode
		Oscillator Period	250	_	—	ns	RC osc mode
		(Note 1)	250	—	10,000	ns	XT osc mode
			250	—	—	ns	HS osc mode (-04)
			100	_	250	ns	HS osc mode (-10)
			50	_	250	ns	HS osc mode (-20)
			5	—	—	μs	LP osc mode
2	Тсү	Instruction Cycle Time (Note 1)	200	TCY	DC	ns	Tcy = 4/Fosc
3	TosL,	External Clock in (OSC1) High or	100		—	ns	XT oscillator
	TosH	Low Time	2.5	—	—	μS	LP oscillator
			15	—	—	ns	HS oscillator
4	TosR,	External Clock in (OSC1) Rise or			25	ns	XT oscillator
	TosF	Fall Time	—	—	50	ns	LP oscillator
			—	—	15	ns	HS oscillator

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** Instruction cycle period (TcY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions, with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "max." cycle time limit is "DC" (no clock) for all devices.

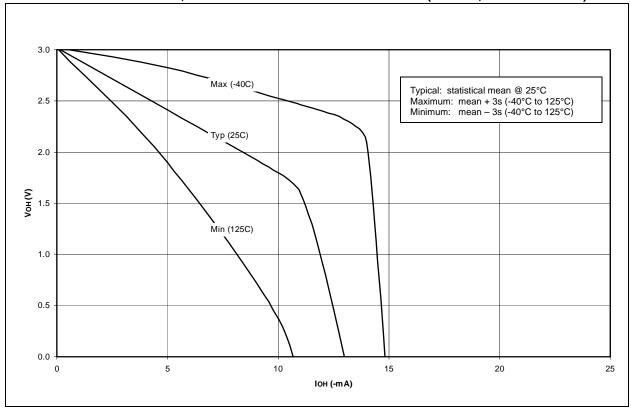
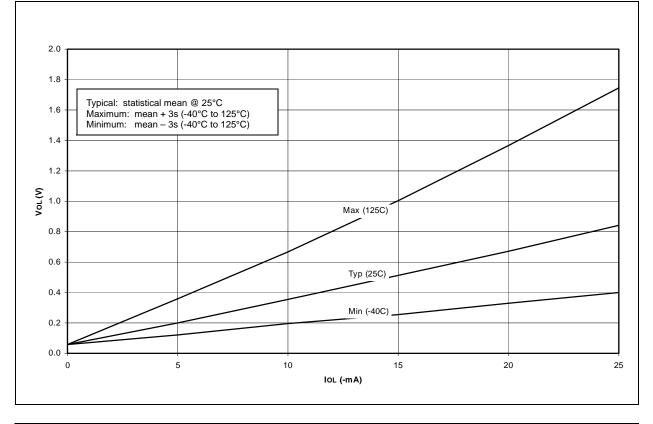


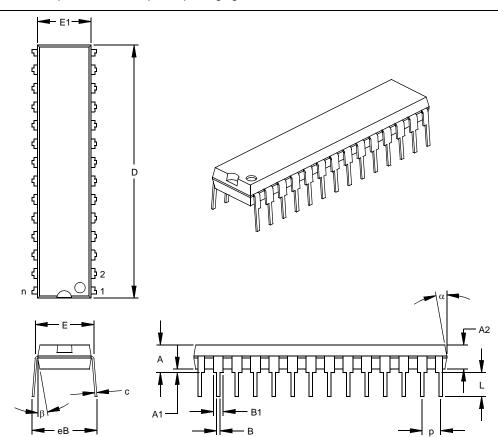
FIGURE 16-17: TYPICAL, MINIMUM AND MAXIMUM VOH vs. IOH (VDD=3V, -40°C TO 125°C)





## 28-Lead Skinny Plastic Dual In-line (SP) – 300 mil (PDIP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		INCHES*		Μ	IILLIMETERS	
Dimens	ion Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		28			28	
Pitch	р		.100			2.54	
Top to Seating Plane	Α	.140	.150	.160	3.56	3.81	4.06
Molded Package Thickness	A2	.125	.130	.135	3.18	3.30	3.43
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	E	.300	.310	.325	7.62	7.87	8.26
Molded Package Width	E1	.275	.285	.295	6.99	7.24	7.49
Overall Length	D	1.345	1.365	1.385	34.16	34.67	35.18
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	С	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.040	.053	.065	1.02	1.33	1.65
Lower Lead Width	В	.016	.019	.022	0.41	0.48	0.56
Overall Row Spacing	§ eB	.320	.350	.430	8.13	8.89	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

\* Controlling Parameter § Significant Characteristic

Dimension D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed

.010" (0.254mm) per side. JEDEC Equivalent: MO-095

Drawing No. C04-070

Notes:

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